



The EVGA Z170 Stinger motherboard is engineered to exceed the best. Featuring a next generation Intel Z170 Express Chipset with DDR4 3200MHz+ memory support, this motherboard is built to perform. Four native SATA 6G ports, eight native USB 3.0 provide robust storage and I/O options, and the mITX form factor allows for an extremely compact performance system.

KEY SPECS

- Supports Intel® Core 6th Generation Processor Family for LGA Socket 1151
- 150% Increased Gold Content
- Intel[®] Z170 Chipset
- Enthusiast Layout
- 2 DIMM Dual-Channel DDR4 3200MHz+ (32GB)
- PCI Express[®] 3.0 Ready
- 2 USB 2.0 ports (two rear panel)
- 1 HDMI Port
- 1 DisplayPort 1.2 Port

- 8 USB 3.0 Ports (six rear panel, two onboard)
- 4 SATA 6G Ports
- 1 M.2 (Key E)
- 1 Intel[®] Gigabit Ethernet Port (10/100/1000)
- 8 Channel HD Audio
- mITX Form Factor

DESIGN DETAILS

Supported CPUs - Intel® 6th Generation Socket 1151 Processors Socket Type - LGA 1151 PCH - Intel® Z170 PCH

DIMM QTY - 2 DIMM Slots Memory Type - DDR4 Up to 3200MHz+ **Memory Capacity - 32GB**

SATA 6Gb/s Ports/Controller - 4 / Intel® Z170 PCH RAID Support - RAID 0, 1,5 and 10

USB 2.0 Ports/Controller - 2 / Intel® Z170 PCH USB 3.0 Ports/Controller - 8 / Intel® Z170 PCH **Network Speed - 10/1000/1000** Network Ports/Controller - 1 / Intel® i219 Gigabit Ethernet PHY

Audio - 8 Channel HD Audio Controller - Realtek HD Audio + Optical

PCI-E Slot Arrangement - 1x16 PCI-E x16 Mechanical Slots - 1 M.2 / 1x Key E

BIOS Type - Full UEFI with mouse/keyboard control Software - EVGA E-LEET X Tuning Utility

Fan Headers - 3 / 4-Pin PWM

DIMENSIONS | | | | | |

 Width: 6.7in – 170.18mm Length: 6.7in – 170.18mm

Form Factor: Mini-ITX

ACCESSORIES • 4

- EVGA Driver Installation Disc
- Rear Case I/O Panel
- Rear Case I/O Cover
- 2 SATA 6G Data Cables
- Manual



PRODUCT WARRANTY







PART NUMBER: 111-SS-E172 FEATURES

FULL UEFI GUI BIOS INTERFACE

Focused on functionality



ONBOARD CPU TEMP MONITOR

Monitor CPU temps quickly & easily



E-LEET X TUNING UTILITY

Adjust your overclocking in 0.S.



4 PHASE PWM

Cleanest variable power switching



PASSIVE CHIPSET HEATSINK

No fans, lower noise, longer lifespan



10 LAYER PCB

Improved overclock stability and PCB cooling



HIGHER GOLD CONTENT

Lower inductance, better power delivery!



ONBOARD POWER

Reset and CMOS Reset Buttons – Power at your fingertips.









PRODUCT WARRANTY





